BY459F-1500

GENERAL DESCRIPTION

Glass-passivated double diffused rectifier diode in a full pack plastic envelope, featuring fast forward recovery and low forward recovery voltage. The device is intended for use in multi-sync monitor horizontal deflection circuits.

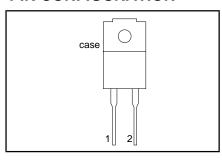
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{RRM}	Repetitive peak reverse voltage Forward voltage	1500 1.2	V
I _{FWM}	Working peak forward current Repetitive peak forward current	10 100	A A
t _{fr}	Forward recovery time Forward recovery voltage	250 14	ns V

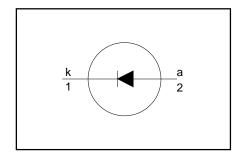
PINNING - SOD100

PIN	DESCRIPTION	
1	cathode	
2	anode	
case	isolated	

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RSM}	Non-repetitive peak reverse voltage during flash-over of picture tube		-	1500	V
V _{RRM} V _{RWM} I _{FWM} I _{FRM}	Repetitive peak reverse voltage Crest working reverse voltage	f = 82kHz; T _{hs} ≤ 127 °C	- - - - -	1500 1300 10 100 100 1100	V
$\left egin{array}{c} T_{stg} \\ T_{j} \end{array} \right $	Storage temperature Operating junction temperature	T T T TAVINI(IIIAA)	-40 -	150 150	O, C

ISOLATION LIMITING VALUE & CHARACTERISTIC

 T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Repetitive peak voltage from both terminals to external heatsink	R.H. ≤ 65% ; clean and dustfree	1		1500	V
C _{isol}	Capacitance from cathode to external heatsink	f = 1 MHz	-	12	1	pF

¹ Including worst case forward recovery losses, see fig:5.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs}	heatsink	with heatsink compound without heatsink compound in free air		- - 55	4.8 5.9 -	K/W K/W K/W
ur j-a	ambient					

STATIC CHARACTERISTICS

 $T_j = 25$ °C unless otherwise stated

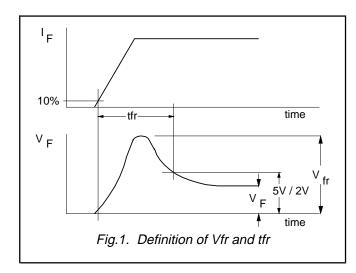
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 6.5 A	-	0.95	1.3	V
	_	I _F = 6.5 A; T _i = 125 °C	-	0.85	1.2	V
I _R	Reverse current	$V_R = V_{RWMmax}$	-	-	0.25	mΑ
		$V_R = V_{RWMmax}$; $T_j = 125 ^{\circ}C$	-	-	1.0	mA

DYNAMIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{fr}		$I_F = 6.5 \text{ A}; dI_F/dt = 50 \text{ A/}\mu\text{s}$	-	8	14	V
t _{fr}	Forward recovery time	$I_F = 6.5 \text{ A}$; $dI_F/dt = 50 \text{ A/}\mu\text{s}$; $V_F = 5 \text{ V}$	-	170	250	ns
		$ I_F = 6.5 \text{ A}; dI_F/dt = 50 \text{ A/}\mu\text{s}; V_F = 2 \text{ V} $	-	350	-	ns
t _{rr}		$ I_{\rm F} = 1 \text{ A}; -dI_{\rm F}/dt = 50 \text{ A}/\mu\text{s}; V_{\rm R} \ge 30 \text{ V} $		250	350	ns
Qs	Reverse recovery charge	$I_F = 2 \text{ A}; -dI_F/dt = 20 \text{ A/}\mu\text{s}; V_R \ge 30 \text{ V}$	-	2.0	3.0	μC

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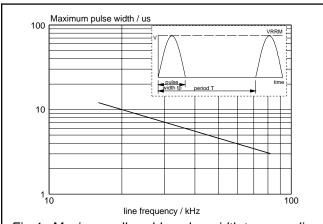
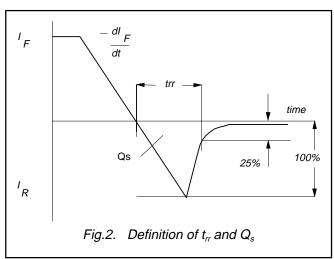


Fig.4. Maximum allowable pulse width t_p versus line frequency; Basic horizontal deflection circuit.



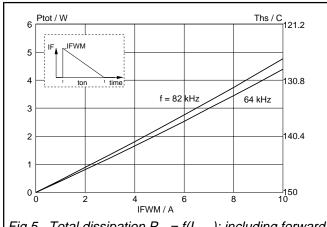
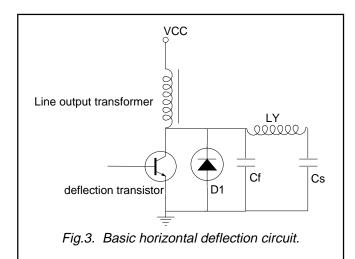


Fig.5. Total dissipation $P_{tot} = f(I_{FWM})$; including forward recovery losses; Basic horizontal deflection circuit.



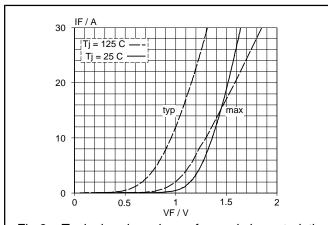


Fig.6. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_i

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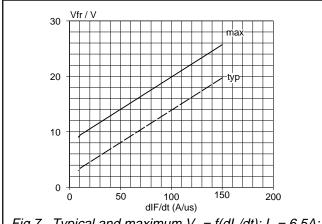
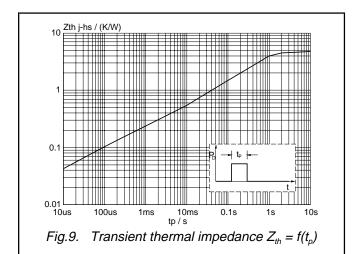


Fig.7. Typical and maximum $V_{fr} = f(dI_F/dt)$; $I_F = 6.5A$; $T_j = 25 \degree C$



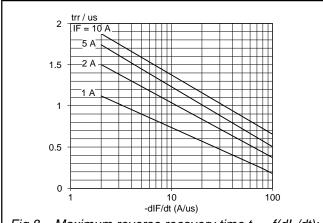
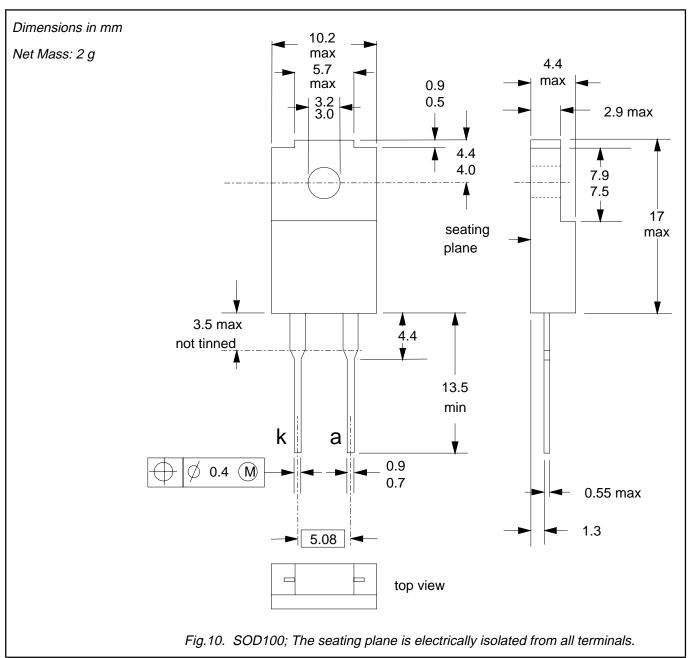


Fig.8. Maximum reverse recovery time $t_{rr} = f(dI_F/dt)$; parameter T_j ; $V_R \ge 30V$

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MECHANICAL DATA



- Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Product specification	This data sheet contains final product specifications.

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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